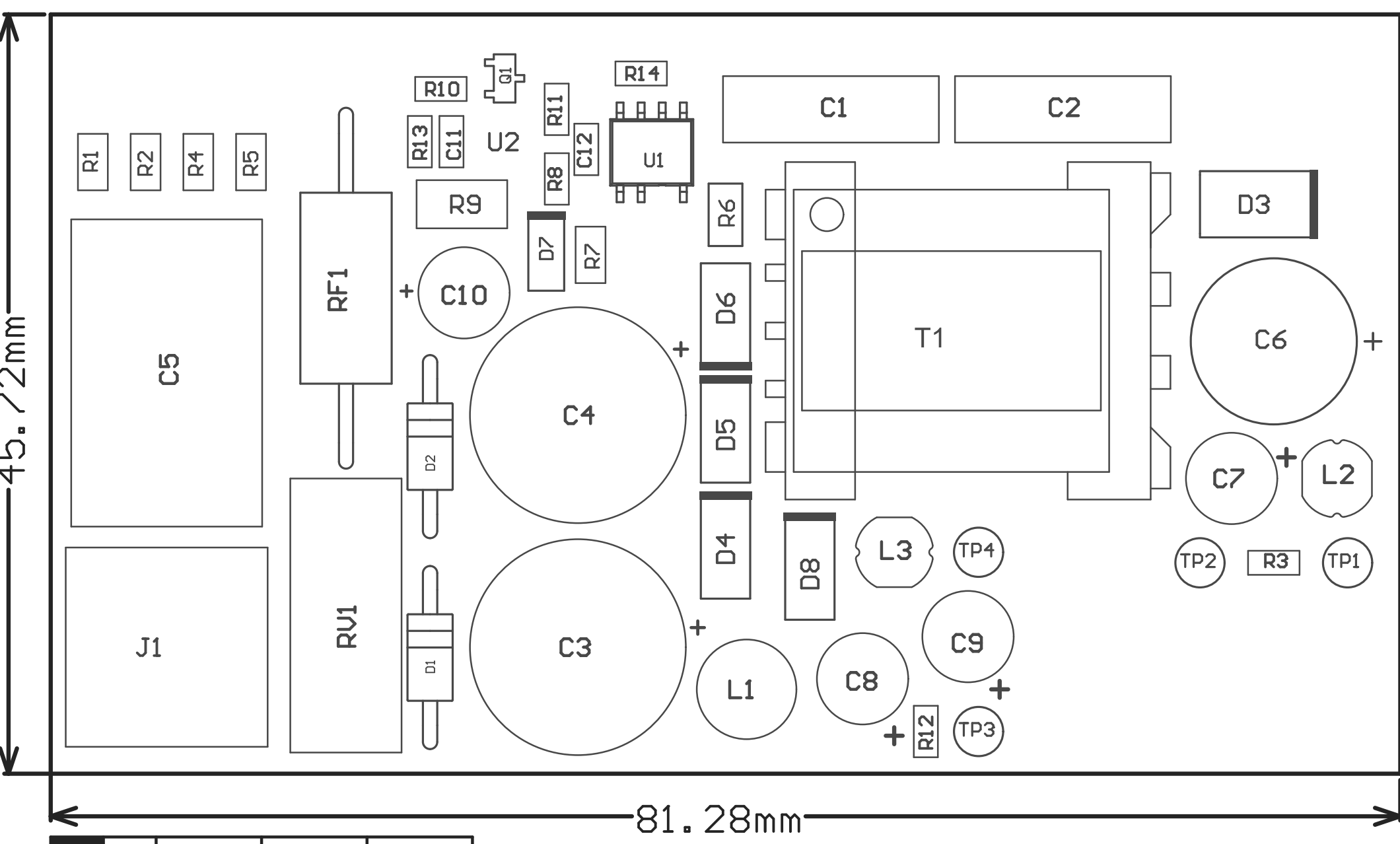
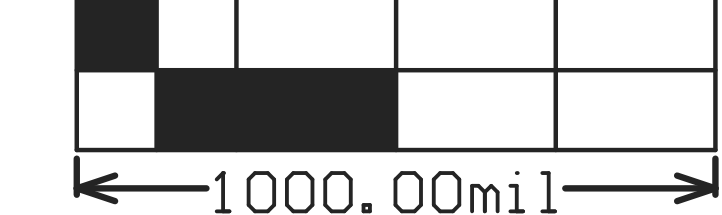


The reference design PMP30070 Rev_C has been built on PMP30070 Rev_A Board



PCB VIEWED FROM TOP SIDE

M2 Board Dimensions
M1 Board Outline



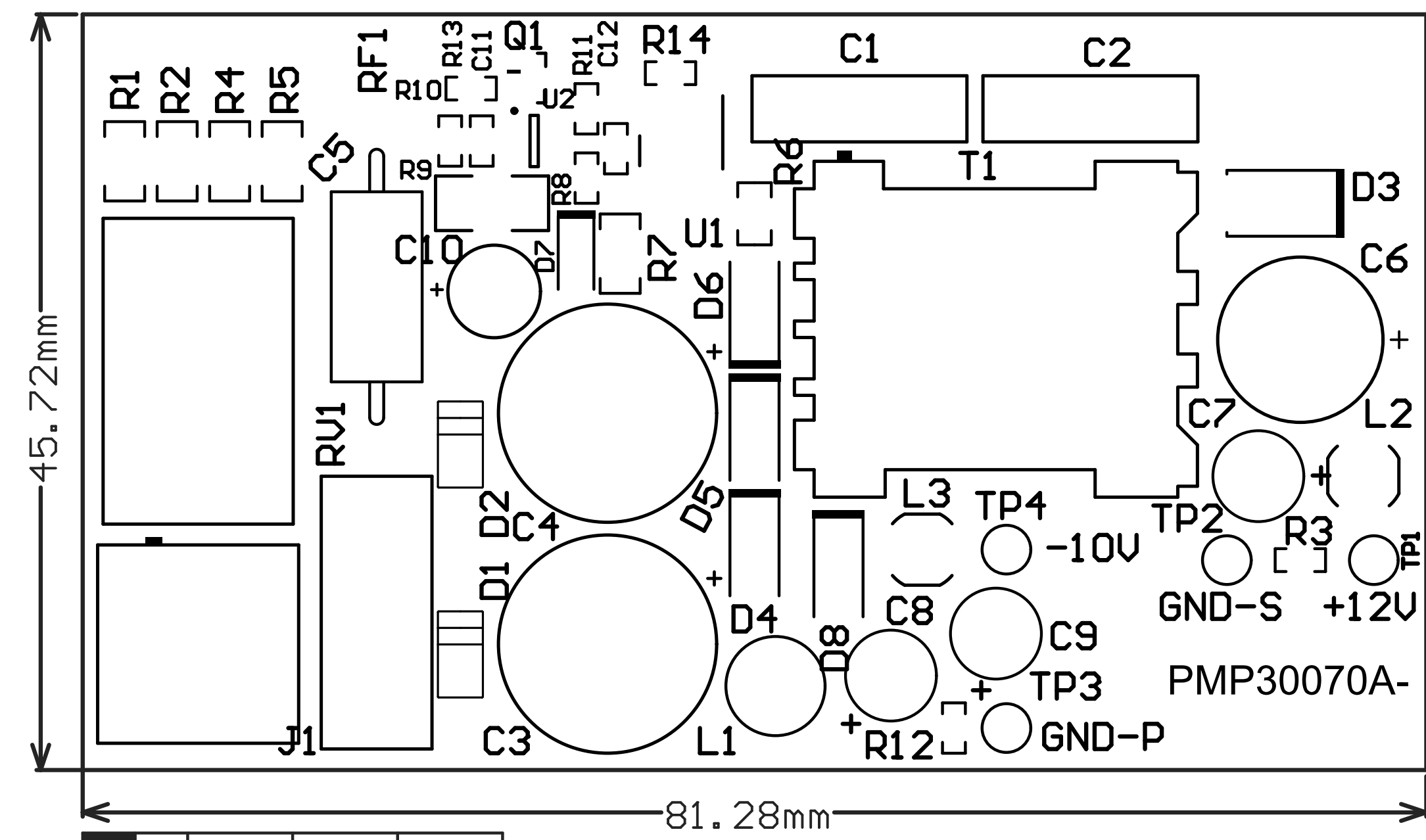
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]



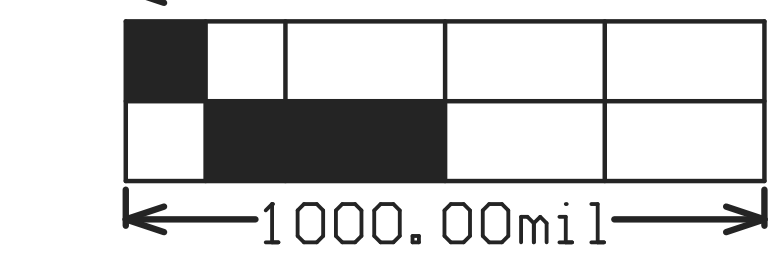
PROJECT TITLE: 90-350VAC to 12V and -10V 8.5W Isolated Flypack	
DESIGNED FOR: Public Release	
FILE NAME: PMP30070 Rev_A PCB.PcbDoc	
ENGINEER: R. Scibilia	LAYOUT BY: R. Scibilia
SCALE: 1.00	ALTIUM DESIGNER VERSION: 16.0.9.368

M9 Title Sheet	BOARD #: PMP30070	REV: A	SUN REV: Not In VersionControl
PLOT NAME = Top Layer Assembly Drawing	GENERATED : 10/13/2016 11:24:56 AM	TEXAS INSTRUMENTS	

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Top Overlay
 M2 Board Dimensions
 M1 Board Outline



M9 Title Sheet

PROJECT TITLE: 90-350VAC to 12V and -10V 8.5W Isolated Flyback	
DESIGNED FOR: Public Release	
FILE NAME: PMP30070 Rev_A PCB.PcbDoc	
ENGINEER: R. Scibilia	LAYOUT BY: R. Scibilia
SCALE: 1.00	ALTIUM DESIGNER VERSION: 16.0.9.368

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